

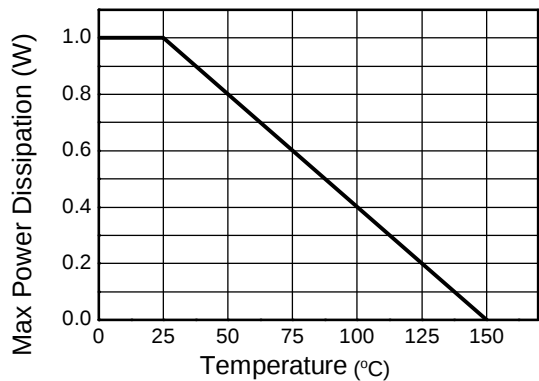
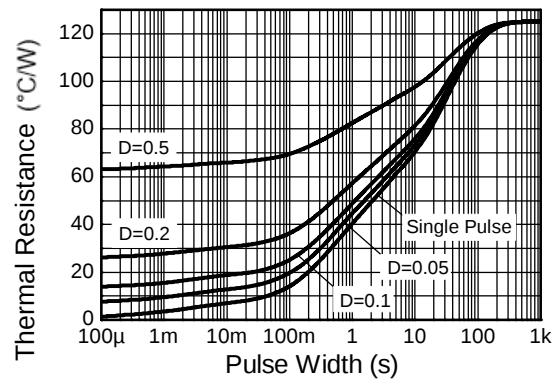
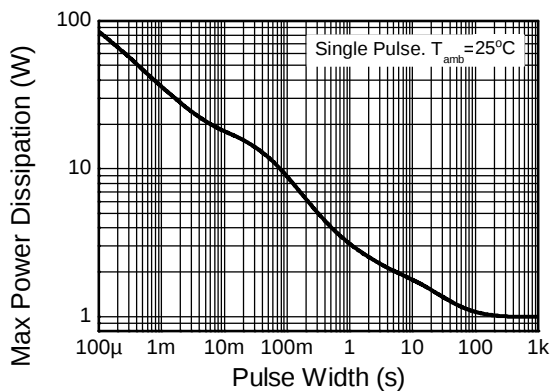
Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-50	V
Collector-Emitter Voltage	V _{CEO}	-50	V
Emitter-Base Voltage	V _{EBO}	-6	V
Continuous Collector Current	I _C	-2	A
Peak Pulse Current	I _{CM}	-2.5	A
Base Current	I _B	-500	mA

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	1	W
Thermal Resistance, Junction to Ambient (Note 5)	R _{θJA}	125	°C/W
Thermal Resistance, Junction to Leads (Note 6)	R _{θJL}	18.3	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Notes: 5. For a device surface mounted on 15mm x 15mm x 0.6mm FR4 PCB with high coverage of single sided 1 oz copper, in still air conditions; the device is measured when operating in steady state condition.
 6. Thermal resistance from junction to solder-point (on the exposed collector pad).

Thermal Characteristics and Derating Information

Derating Curve

Transient Thermal Impedance

Pulse Power Dissipation

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	-50	—	—	V	I _C = -100μA
Collector-Emitter Breakdown Voltage (Note 7)	BV _{CEO}	-50	—	—	V	I _C = -10mA
Emitter-Base Breakdown Voltage	BV _{EBO}	-6	—	—	V	I _E = -100μA
Collector Cut-Off Current	I _{CBO}	—	—	-100	nA	V _{CB} = -50V
Emitter Cut-Off Current	I _{EBO}	—	—	-100	nA	V _{EB} = -5V
DC Current Gain (Note 7)	2DA1213O	70	—	140	—	I _C = -500mA, V _{CE} = -2V
	2DA1213Y	120		240		I _C = -500mA, V _{CE} = -2V
	2DA1213O, 2DA1213Y	20		—		I _C = -2A, V _{CE} = -2V
Collector-Emitter Saturation Voltage (Note 7)	V _{CE(sat)}	—	—	-0.5	V	I _C = -1A, I _B = -50mA
Base-Emitter Turn-On Voltage (Note 7)	V _{BE(sat)}	—	—	-1.2	V	I _C = -1A, I _B = -50mA
Transition Frequency	f _T	—	160	—	MHz	I _C = -100mA, V _{CE} = -2V, f = 100MHz
Output Capacitance	C _{obo}	—	17	—	pF	V _{CB} = -10V, I _E = 0, f = 1MHz
Turn-On Time	t _{on}	—	25	—	ns	V _{CE} = -2V, I _C = -1A, I _{B1} = -I _{B2} = -50mA
Storage Time	t _(s)	—	130	—	ns	
Fall Time	t _(f)	—	12	—	ns	

Note: 7. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%.

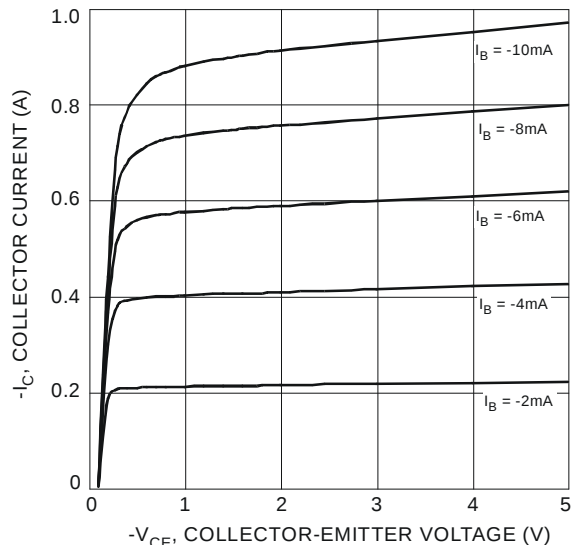
Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)


Figure 1 Typical Collector Current vs. Collector-Emitter Voltage

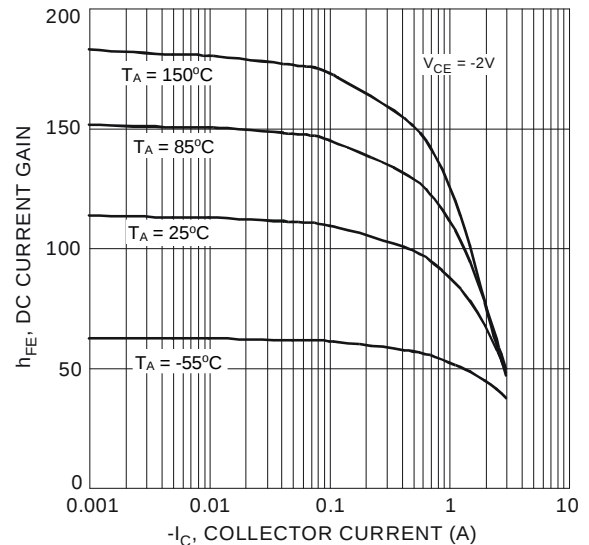


Figure 2 Typical DC Current Gain vs. Collector Current (2DA1213O)

Typical Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.) (continued)

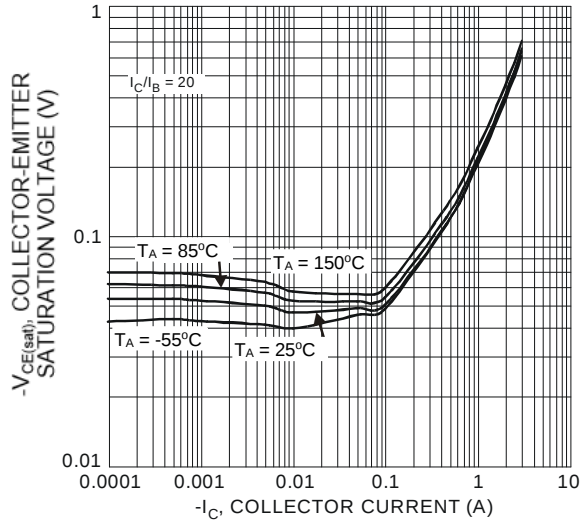


Figure 3 Typical Collector-Emitter Saturation Voltage vs. Collector Current

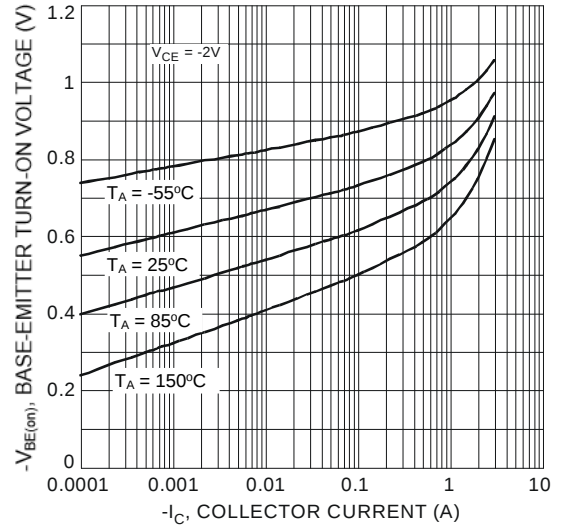


Figure 4 Typical Base-Emitter Turn-On Voltage vs. Collector Current

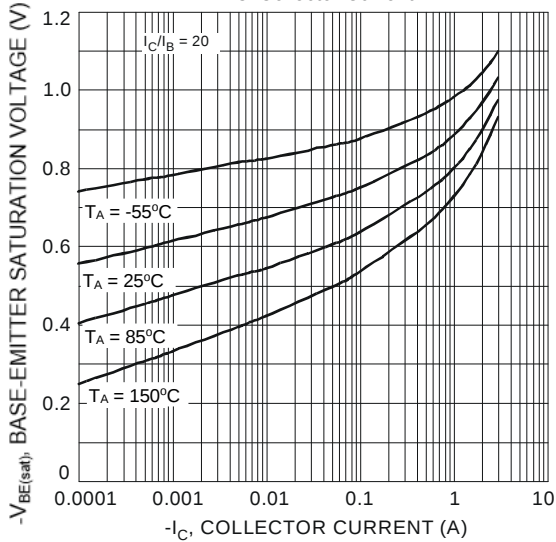


Figure 5 Typical Base-Emitter Saturation Voltage vs. Collector Current

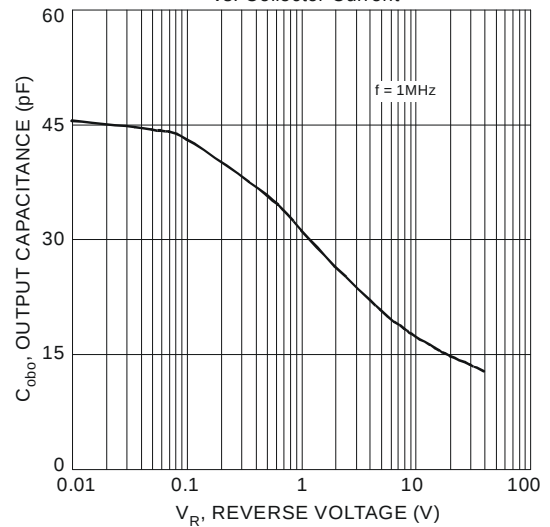


Figure 6 Typical Output Capacitance Characteristics

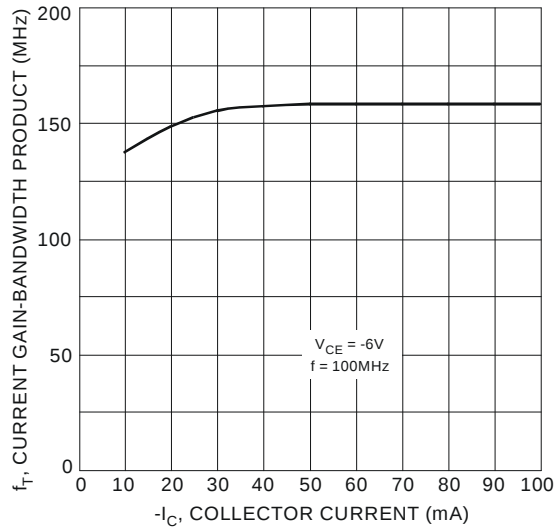
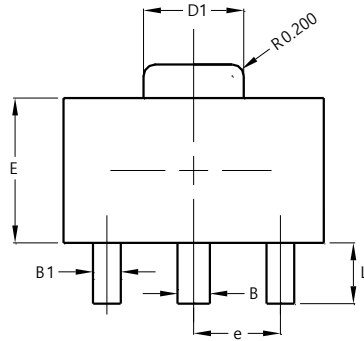


Figure 7 Typical Gain-Bandwidth Product vs. Collector Current

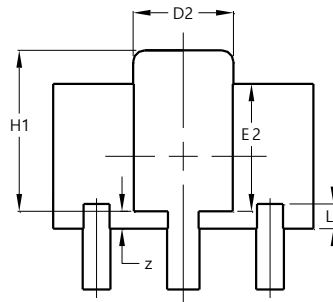
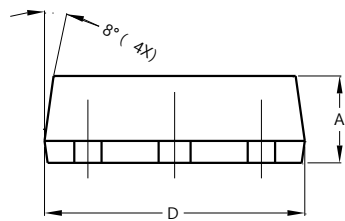
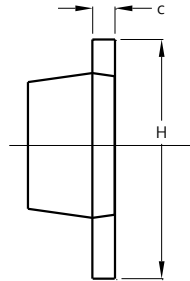
Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT89



TOP VIEW



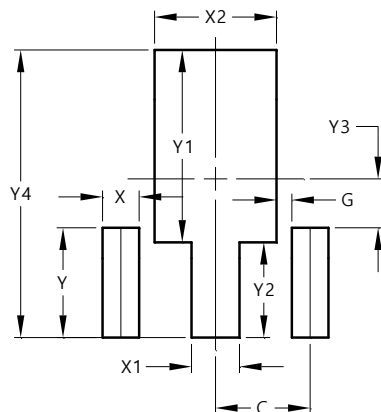
BOTTOM VIEW

SOT89			
Dim	Min	Max	Typ
A	1.40	1.60	1.50
B	0.50	0.62	0.56
B1	0.42	0.54	0.48
c	0.35	0.43	0.38
D	4.40	4.60	4.50
D1	1.62	1.83	1.733
D2	1.61	1.81	1.71
E	2.40	2.60	2.50
E2	2.05	2.35	2.20
e	-	-	1.50
H	3.95	4.25	4.10
H1	2.63	2.93	2.78
L	0.90	1.20	1.05
L1	0.327	0.527	0.427
z	0.20	0.40	0.30
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT89



Dimensions	Value (in mm)
C	1.500
G	0.244
X	0.580
X1	0.760
X2	1.933
Y	1.730
Y1	3.030
Y2	1.500
Y3	0.770
Y4	4.530

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